XP152A12C0MR-G

ETR1121_003

Power MOSFET

■GENERAL DESCRIPTION

The XP152A12C0MR-G is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance : Rds(on) = 0.3Ω @ Vgs = -4.5V

: Rds(on) = 0.5Ω @ Vgs = -2.5V

Ultra High-Speed Switching Gate Protect Diode Built-in Driving Voltage

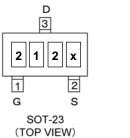
: -2.5V **P-Channel Power MOSFET**

DMOS Structure

Small Package : SOT-23

Environmentally Friendly: EU RoHS Compliant, Pb Free

■PIN CONFIGURATION/ MARKING



S : Source D : Drain

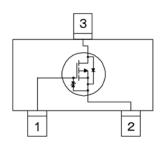
G : Gate

■ PIN ASSIGNMENT

PRODUCTS	PACKAGE	ORDER UNIT
XP152A12C0MR	SOT-23	3,000/Reel
XP152A12C0MR-G ^(*)	SOT-23	3,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■EQUIVALENT CIRCUIT



P-channel MOSFET (1 device built-in)

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

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PARAMETER	SYMBOL	RATINGS	UNITS		
Drain - Source Voltage	Vdss	-20	V		
Gate - Source Voltage	Vgss	±12	٧		
Drain Current (DC)	ld	-0.7	Α		
Drain Current (Pulse)	Idp	-2.8	Α		
Reverse Drain Current	ldr	-0.7	Α		
Channel Power Dissipation *	Pd	0.5	W		
Channel Temperature	Tch	150	°C		
Storage Temperature	Tstg	-55~150	°C		

^{*} When implemented on a ceramic PCB

^{*} x represents production lot number.

■ELECTRICAL CHARACTERISTICS

DC Characteristics $Ta = 25^{\circ}C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	Idss	Vds= -20V, Vgs= 0V	-	-	-10	μΑ
Gate-Source Leak Current	Igss	Vgs= ±12V, Vds=0V	-	-	±10	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id= -1mA, Vds= -10V	-0.5	-	-1.2	V
Drain-Source On-State Resistance *1	Rds(on)	Id= -0.4A, Vgs= -4.5V	-	0.23	0.30	Ω
		Id= -0.4A, Vgs= -2.5V	-	0.37	0.50	Ω
Forward Transfer Admittance *1	Yfs	Id= -0.4A, Vds= -10V	-	1.5	-	S
Body Drain Diode Forward Voltage	Vf	If= -0.7A, Vgs= 0V	-	-0.8	-1.1	V

^{*1} Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= -10V, Vgs=0V f= 1MHz	-	180	-	pF
Output Capacitance	Coss		-	120	-	pF
Feedback Capacitance	Crss		-	60	-	pF

Switching Characteristics

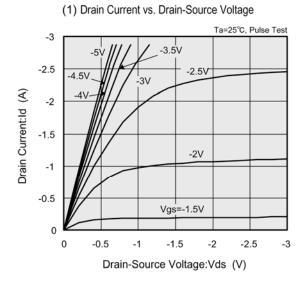
Ta = 25°C

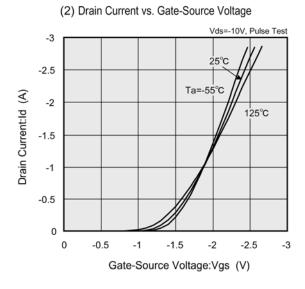
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= -5V, Id= -0.4A Vdd= -10V	1	5	-	ns
Rise Time	tr		-	20	-	ns
Turn-Off Delay Time	td (off)		-	55	-	ns
Fall Time	tf		-	70	-	ns

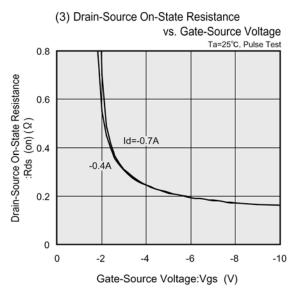
Thermal Characteristics

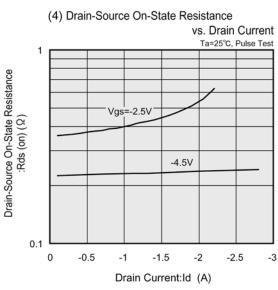
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W

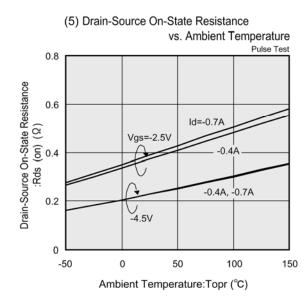
■TYPICAL PERFOMANCE CHARACTERISTICS

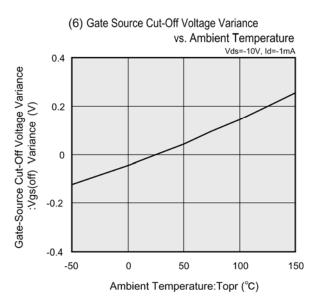




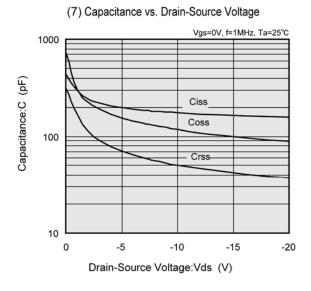


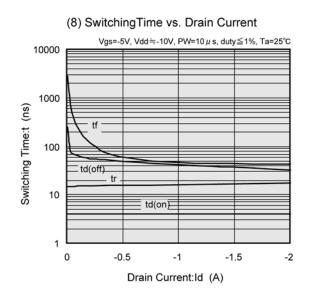


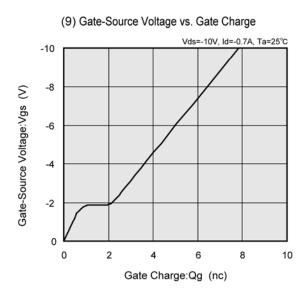


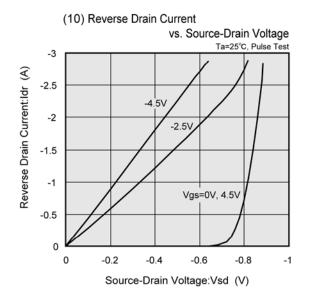


■TYPICAL PERFOMANCE CHARACTERISTICS (Continued)

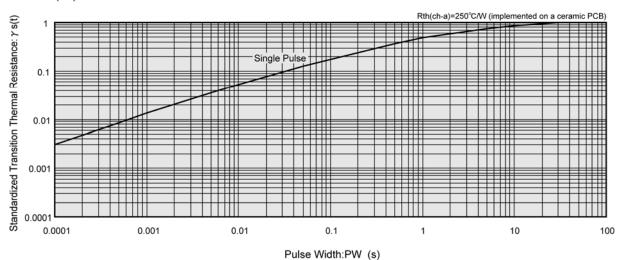








(11) Standardized Transition Thermal Resistance vs. Pulse Width



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